

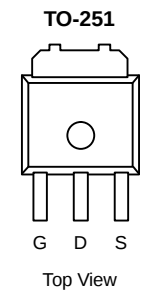


## N-Channel 30-V (D-S) 175°C MOSFET

## PRODUCT SUMMARY

| $V_{DS}$ (V) | $r_{DS(on)}$ ( $\Omega$ ) | $I_D$ (A) <sup>a, b</sup> |
|--------------|---------------------------|---------------------------|
| 30           | 0.007 @ $V_{GS} = 10$ V   | 25                        |
|              | 0.010 @ $V_{GS} = 4.5$ V  | 18                        |

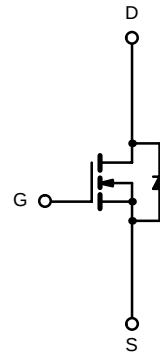
**175°C Rated**  
Maximum Junction Temperature  
**TrenchFET®**  
Power MOSFETs



Order Number:  
SUY50N03-07AP

## Notes:

1. Drain Connected to Tab
2. Leads Trimmed to 0.092"  $\pm$  0.003"



N-Channel MOSFET

ABSOLUTE MAXIMUM RATINGS ( $T_A = 25^\circ\text{C}$  UNLESS OTHERWISE NOTED)

| Parameter                                                              |                           | Symbol         | Limit               | Unit             |
|------------------------------------------------------------------------|---------------------------|----------------|---------------------|------------------|
| Drain-Source Voltage                                                   |                           | $V_{DS}$       | 30                  | V                |
| Gate-Source Voltage                                                    |                           | $V_{GS}$       | $\pm 20$            |                  |
| Continuous Drain Current ( $T_J = 175^\circ\text{C}$ ) <sup>a, b</sup> | $T_A = 25^\circ\text{C}$  | $I_D$          | 25                  | A                |
|                                                                        | $T_A = 100^\circ\text{C}$ |                | 18                  |                  |
| Pulsed Drain Current                                                   |                           | $I_{DM}$       | 100                 |                  |
| Continuous Source Current (Diode Conduction) <sup>a, b</sup>           |                           | $I_S$          | 25                  |                  |
| Maximum Power Dissipation                                              | $T_C = 25^\circ\text{C}$  | $P_D$          | 88                  | W                |
|                                                                        | $T_A = 25^\circ\text{C}$  |                | 8.3 <sup>a, b</sup> |                  |
| Operating Junction and Storage Temperature Range                       |                           | $T_J, T_{stg}$ | -55 to 175          | $^\circ\text{C}$ |

## THERMAL RESISTANCE RATINGS

| Parameter                        |                 | Symbol     | Typical | Maximum | Unit               |
|----------------------------------|-----------------|------------|---------|---------|--------------------|
| Junction-to-Ambient <sup>a</sup> | $t \leq 10$ sec | $R_{thJA}$ | 15      | 18      | $^\circ\text{C/W}$ |
|                                  | Steady State    |            | 40      | 50      |                    |
| Junction-to-Case                 |                 | $R_{thJC}$ | 1.4     | 1.7     |                    |

## Notes

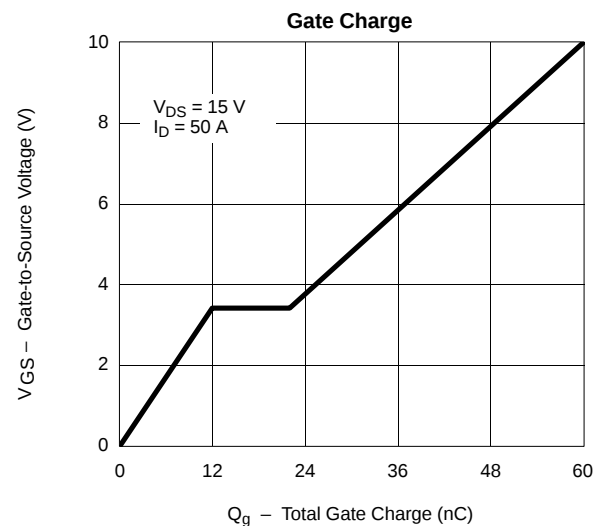
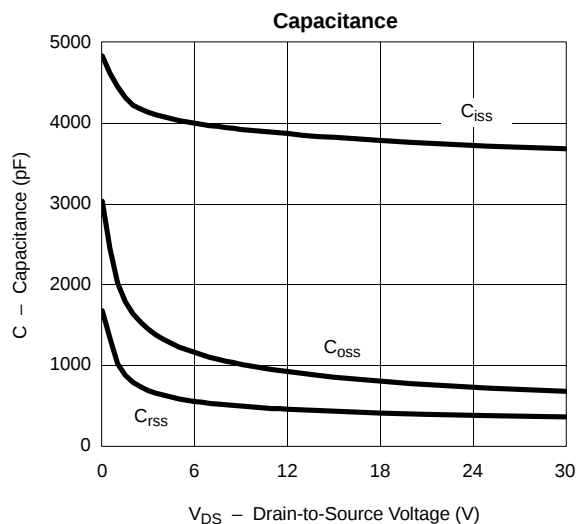
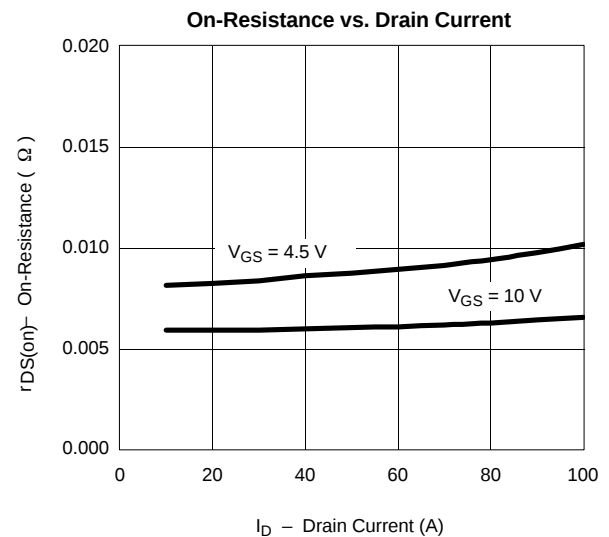
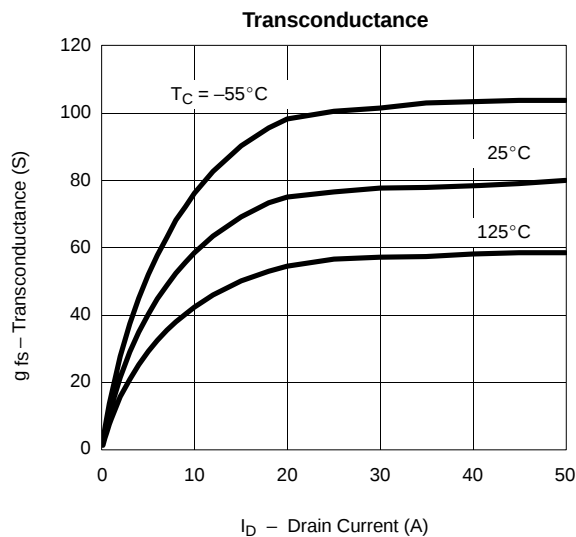
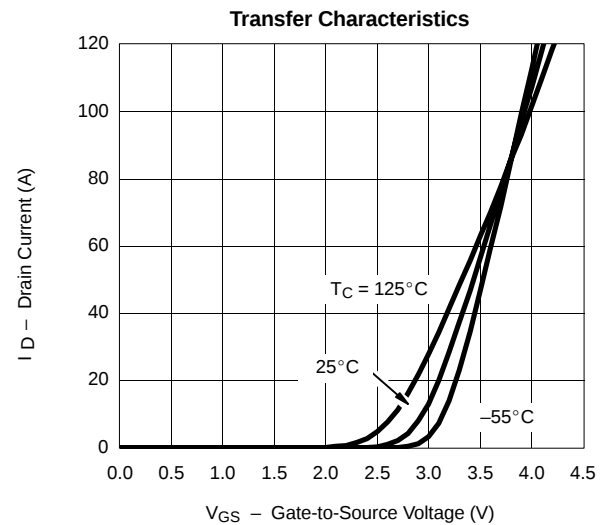
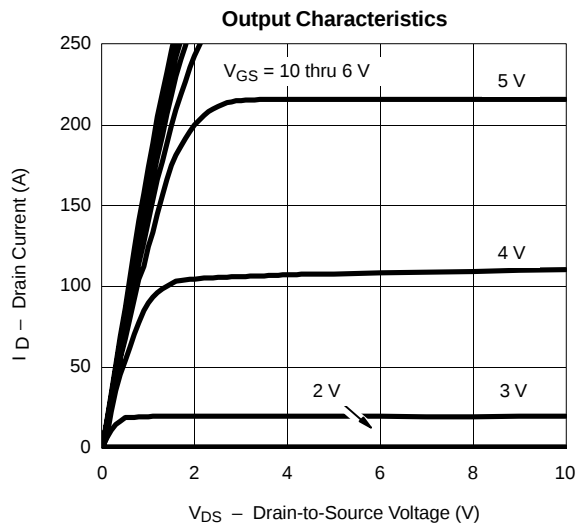
- a. Surface Mounted on 1" x1" FR4 Board.  
b.  $t \leq 10$  sec.

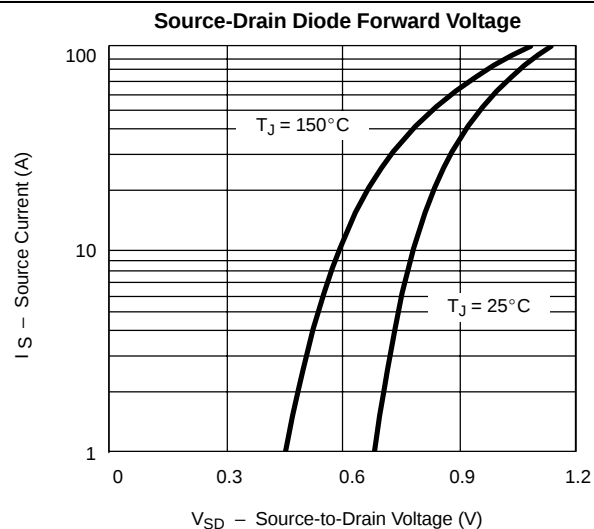
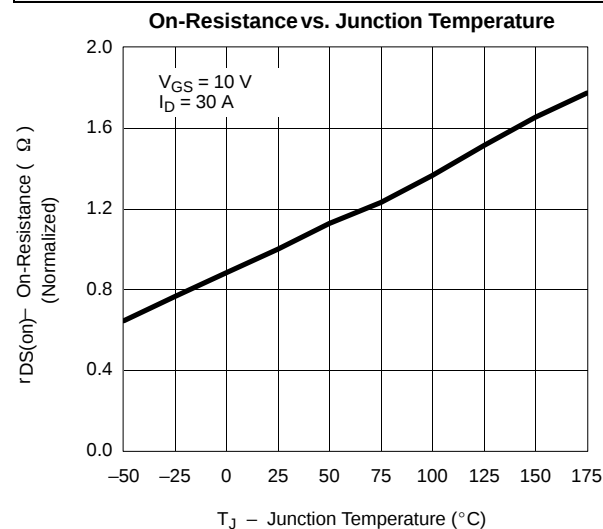
**SPECIFICATIONS (T<sub>J</sub> = 25 °C UNLESS OTHERWISE NOTED)**

| Parameter                                                             | Symbol               | Test Condition                                                                                                           | Min | Typ <sup>a</sup> | Max   | Unit |
|-----------------------------------------------------------------------|----------------------|--------------------------------------------------------------------------------------------------------------------------|-----|------------------|-------|------|
| Static                                                                |                      |                                                                                                                          |     |                  |       |      |
| Drain-Source Breakdown Voltage                                        | V <sub>(BR)DSS</sub> | V <sub>GS</sub> = 0 V, I <sub>D</sub> = 250 μA                                                                           | 30  |                  |       | V    |
| Gate Threshold Voltage                                                | V <sub>GS(th)</sub>  | V <sub>DS</sub> = V <sub>GS</sub> , I <sub>D</sub> = 250 μA                                                              | 1.0 | 2.0              |       |      |
| Gate-Body Leakage                                                     | I <sub>GSS</sub>     | V <sub>DS</sub> = 0 V, V <sub>GS</sub> = ±20 V                                                                           |     |                  | ± 100 | nA   |
| Zero Gate Voltage Drain Current                                       | I <sub>DSS</sub>     | V <sub>DS</sub> = 30 V, V <sub>GS</sub> = 0 V                                                                            |     |                  | 1     | μA   |
|                                                                       |                      | V <sub>DS</sub> = 30 V, V <sub>GS</sub> = 0 V, T <sub>J</sub> = 125°C                                                    |     |                  | 50    |      |
| On-State Drain Current <sup>b</sup>                                   | I <sub>D(on)</sub>   | V <sub>DS</sub> = 5 V, V <sub>GS</sub> = 10 V                                                                            | 50  |                  |       | A    |
| Drain-Source On-State Resistance <sup>b</sup>                         | r <sub>DS(on)</sub>  | V <sub>GS</sub> = 10 V, I <sub>D</sub> = 20 A                                                                            |     |                  | 0.007 | Ω    |
|                                                                       |                      | V <sub>GS</sub> = 10 V, I <sub>D</sub> = 20 A, T <sub>J</sub> = 125°C                                                    |     |                  | 0.011 |      |
|                                                                       |                      | V <sub>GS</sub> = 4.5 V, I <sub>D</sub> = 20 A                                                                           |     |                  | 0.010 |      |
| Forward Transconductance <sup>b</sup>                                 | g <sub>fs</sub>      | V <sub>DS</sub> = 15 V, I <sub>D</sub> = 20 A                                                                            | 20  |                  |       | S    |
| Dynamic <sup>a</sup>                                                  |                      |                                                                                                                          |     |                  |       |      |
| Input Capacitance                                                     | C <sub>iss</sub>     | V <sub>GS</sub> = 0 V, V <sub>DS</sub> = 25 V, F = 1 MHz                                                                 |     | 3720             |       | pF   |
| Output Capacitance                                                    | C <sub>oss</sub>     |                                                                                                                          |     | 715              |       |      |
| Reverse Transfer Capacitance                                          | C <sub>rss</sub>     |                                                                                                                          |     | 370              |       |      |
| Total Gate Charge <sup>c</sup>                                        | Q <sub>g</sub>       | V <sub>DS</sub> = 15 V, V <sub>GS</sub> = 10 V, I <sub>D</sub> = 50 A                                                    |     | 60               | 120   | nC   |
| Gate-Source Charge <sup>c</sup>                                       | Q <sub>gs</sub>      |                                                                                                                          |     | 12               |       |      |
| Gate-Drain Charge <sup>c</sup>                                        | Q <sub>gd</sub>      |                                                                                                                          |     | 10               |       |      |
| Turn-On Delay Time <sup>c</sup>                                       | t <sub>d(on)</sub>   | V <sub>DD</sub> = 15 V, R <sub>L</sub> = 0.3 Ω<br>I <sub>D</sub> ≅ 50 A, V <sub>GEN</sub> = 10 V, R <sub>G</sub> = 2.5 Ω |     | 11               | 25    | ns   |
| Rise Time <sup>c</sup>                                                | t <sub>r</sub>       |                                                                                                                          |     | 6                | 15    |      |
| Turn-Off Delay Time <sup>c</sup>                                      | t <sub>d(off)</sub>  |                                                                                                                          |     | 50               | 100   |      |
| Fall Time <sup>c</sup>                                                | t <sub>f</sub>       |                                                                                                                          |     | 11               | 20    |      |
| Source-Drain Diode Ratings and Characteristic (T <sub>C</sub> = 25°C) |                      |                                                                                                                          |     |                  |       |      |
| Pulsed Current                                                        | I <sub>SM</sub>      |                                                                                                                          |     |                  | 100   | A    |
| Diode Forward Voltage <sup>b</sup>                                    | V <sub>SD</sub>      | I <sub>F</sub> = 100 A, V <sub>GS</sub> = 0 V                                                                            |     | 1.2              | 1.5   | V    |
| Source-Drain Reverse Recovery Time                                    | t <sub>rr</sub>      | I <sub>F</sub> = 50 A, di/dt = 100 A/μs                                                                                  |     | 45               | 100   | ns   |

## Notes

- a. Guaranteed by design, not subject to production testing.  
b. Pulse test; pulse width ≤ 300 μs, duty cycle ≤ 2%.  
c. Independent of operating temperature.

**TYPICAL CHARACTERISTICS (25°C UNLESS NOTED)**

**TYPICAL CHARACTERISTICS (25°C UNLESS NOTED)****THERMAL RATINGS**